7402 SPECIFICATIONS

CHANNELS PER CARD: 9 plus temperature reference.

CONTACT CONFIGURATION: 2 pole form A, with common guard.

ISOTHERMAL BLOCK:

Temperature Offset: $\pm 0.05^{\circ}$ C maximum from HI to LO of any channel or between any two adjacent channels in a column of the isothermal block. $\pm 0.1^{\circ}$ C maximum between any two terminals on the isothermal block. Maximum additional dynamic offset due to 10°C step change in environment; $\pm 0.1^{\circ}$ C after 1 hour settling.

Connector type: Screw terminals, No. 18 AWG wire maximum.

TEMPERATURE REFERENCE:

Type: Semiconductor, temperature dependent current source.

Output: +200µV/°C, (+54.63mV @ 0°C).

Accuracy: ±0.25°C (10°-35°C), ±0.50°C (0°-10°C and 35°-50°C).

RELAY:

Drive Current: 12mA per relay (typical).

Actuation Time: <5ms, exclusive of mainframe.

Contact Offset Voltage: <1µV.

Maximum Signal Level: 42V, 100mA, 2VA (non-inductive load only).

Contact Life: >10^a closures (dry circuit), >10^a at maximum signal level.

Contact Resistance: $< 0.7\Omega$ initial ($< 2\Omega$ to rated contact life).

ISOLATION:

Channel: >10^{**a**}Ω, <10pE.

Input: >10' Ω , <150pE.

Common Mode Voltage: 200V peak.

ENVIRONMENT:

Operating: 0° -50°C, 0% to 70% relative humidity up to 35°C; linearly derate 3% RH/°C, 35° -50°C.

Storage: -25° to $+65^{\circ}$ C.

DIMENSIONS, WEIGHT: 32mm high \times 114mm wide \times 272mm long (14 in. \times 44 in. \times 10% in.). Net weight 0.64kg (1 lb. 6.5 oz.).